## Important notice

Dear Customer,
On 7 February 2017 the former NXP Standard Product business became a new company with the tradename Nexperia. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of http://www.nxp.com, http://www.philips.com/ or http://www.semiconductors.philips.com/, use http://www.nexperia.com

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use salesaddresses@nexperia.com (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved
Should be replaced with:
- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via salesaddresses@nexperia.com). Thank you for your cooperation and understanding,

Kind regards,
Team Nexperia

## 74HC365; 74HCT365

Hex buffer/line driver; 3-state
Rev. 4 - 27 January 2016
Product data sheet

## 1. General description

The 74 HC 365 ; 74 HCT 365 is a hex buffer/line driver with 3-state outputs controlled by the output enable inputs (OEn). A HIGH on OEn causes the outputs to assume a high impedance OFF-state. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of $\mathrm{V}_{\mathrm{cc}}$.

## 2. Features and benefits

- Inverting outputs
- Input levels:
- For 74HC365: CMOS level
- For 74HC365: TTL level
- Complies with JEDEC standard no. 7A
- ESD protection:
- HBM JESD22-A114F exceeds 2000 V
- MM JESD22-A115-A exceeds 200 V
- Specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and from $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
- Multiple package options


## 3. Ordering information

Table 1. Ordering information

| Type number | Package |  |  |  | Version |
| :--- | :--- | :--- | :--- | :--- | :--- |
|  | Temperature range | Name | Description | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |
| 74 HC 365 D | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SO16 |  |  |  |
| 74 HCT 365 D |  |  | plastic shrink small outline package; 16 leads; body width <br> 5.3 mm | SOT338-1 |  |
| 74 HC 365 DB | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | SSOP16 |  |  |  |



## 4. Functional diagram



Fig 1. Functional diagram


Fig 2. Logic symbol


Fig 3. IEC logic symbol


Fig 4. Logic diagram

## 5. Pinning information

### 5.1 Pinning



Fig 5. Pin configuration

### 5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
| :---: | :---: | :---: |
| OE1 | 1 | output enable input 1 (active LOW) |
| 1A | 2 | data input 1 |
| 1Y | 3 | data output 1 |
| 2A | 4 | data input 2 |
| 2 Y | 5 | data output 2 |
| 3A | 6 | data input 3 |
| 3 Y | 7 | data output 3 |
| GND | 8 | ground (0 V) |
| 4Y | 9 | data output 4 |
| 4A | 10 | data input 4 |
| 5 Y | 11 | data output 5 |
| 5A | 12 | data input 5 |
| 6 Y | 13 | data output 6 |
| 6A | 14 | data input 6 |
| $\overline{\mathrm{OE} 2}$ | 15 | output enable input 2 (active LOW) |
| $\mathrm{V}_{\mathrm{Cc}}$ | 16 | supply voltage |

## 6. Functional description

Table 3. Function table [1]

| Control | Input | Output |  |
| :--- | :--- | :--- | :--- |
| OE1 | OE2 | nA | nY |
| L | L | L | L |
| L | L | H | H |
| X | H | X | Z |
| H | X | X | Z |

[1] $\mathrm{H}=$ HIGH voltage level;
L = LOW voltage level;
X = don't care;
$\mathrm{Z}=$ high-impedance OFF-state.

## 7. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground =0 V).

| Symbol | Parameter | Conditions |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CC }}$ | supply voltage |  |  | -0.5 | +7 | V |
| $\mathrm{I}_{\mathrm{K}}$ | input clamping current | $\mathrm{V}_{1}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{1}>\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ | [1] | - | $\pm 20$ | mA |
| lok | output clamping current | $\mathrm{V}_{\mathrm{O}}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{O}}>\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ | [1] | - | $\pm 20$ | mA |
| lo | output current | $\mathrm{V}_{\mathrm{O}}=-0.5 \mathrm{~V}$ to $\left(\mathrm{V}_{\mathrm{Cc}}+0.5 \mathrm{~V}\right)$ |  | - | $\pm 35$ | mA |
| ICC | supply current |  |  | - | 70 | mA |
| IGND | ground current |  |  | -70 | - | mA |
| $\mathrm{T}_{\text {stg }}$ | storage temperature |  |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{P}_{\text {tot }}$ | total power dissipation | SO16 package | [2] | - | 500 | mW |
|  |  | SSOP16 package | [3] | - | 500 | mW |
|  |  | TSSOP16 package | [3] | - | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] For SO16 packages: $\mathrm{P}_{\text {tot }}$ derates linearly with $8 \mathrm{~mW} / \mathrm{K}$ above $70^{\circ} \mathrm{C}$.
[3] For SSOP16 and TSSOP16 packages: $\mathrm{P}_{\text {tot }}$ derates linearly with $5.5 \mathrm{~mW} / \mathrm{K}$ above $60^{\circ} \mathrm{C}$.

Hex buffer/line driver; 3-state

## 8. Recommended operating conditions

Table 5. Recommended operating conditions Voltages are referenced to GND (ground $=0 \mathrm{~V}$ )

| Symbol | Parameter | Conditions | 74HC365 |  |  | 74HCT365 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max | Min | Typ | Max |  |
| $\mathrm{V}_{\mathrm{Cc}}$ | supply voltage |  | 2.0 | 5.0 | 6.0 | 4.5 | 5.0 | 5.5 | V |
| $V_{1}$ | input voltage |  | 0 | - | $\mathrm{V}_{\mathrm{Cc}}$ | 0 | - | $\mathrm{V}_{\mathrm{Cc}}$ | V |
| $\mathrm{V}_{\mathrm{O}}$ | output voltage |  | 0 | - | $\mathrm{V}_{\mathrm{Cc}}$ | 0 | - | $\mathrm{V}_{\mathrm{Cc}}$ | V |
| $\mathrm{T}_{\text {amb }}$ | ambient temperature |  | -40 | +25 | +125 | -40 | +25 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta t / \Delta \mathrm{V}$ | input transition rise and fall rate | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | - | 625 | - | - | - | $\mathrm{ns} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | 1.67 | 139 | - | 1.67 | 139 | $\mathrm{ns} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 83 | - | - | - | $\mathrm{ns} / \mathrm{V}$ |

## 9. Static characteristics

Table 6. Static characteristics 74HC365
At recommended operating conditions; voltages are referenced to GND (ground $=0 \mathrm{~V}$ ).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{C C}=2.0 \mathrm{~V}$ | 1.5 | 1.2 | - | V |
|  |  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ | 3.15 | 2.4 | - | V |
|  |  | $\mathrm{V}_{C C}=6.0 \mathrm{~V}$ | 4.2 | 3.2 | - | V |
| VIL | LOW-level input voltage | $\mathrm{V}_{C C}=2.0 \mathrm{~V}$ | - | 0.8 | 0.5 | V |
|  |  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ | - | 2.1 | 1.35 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | 2.8 | 1.8 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\mathrm{V}_{\text {I }}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ | - | - | - |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | 1.9 | 2.0 | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 4.4 | 4.5 | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 5.9 | 6.0 | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-6.0 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 3.98 | 4.32 | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-7.8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 5.48 | 5.81 | - | V |
| $\mathrm{V}_{\mathrm{OL}}$ | LOW-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | 0 | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | 0 | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | 0 | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=6.0 \mathrm{~mA} ; \mathrm{V}_{\mathrm{Cc}}=4.5 \mathrm{~V}$ | - | 0.15 | 0.26 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=7.8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{cc}}=6.0 \mathrm{~V}$ | - | 0.16 | 0.26 | V |
| 1 | input leakage current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | $\pm 0.1$ | $\mu \mathrm{A}$ |
| loz | OFF-state output current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | $\pm 0.5$ | $\mu \mathrm{A}$ |
| Icc | supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{GND} ; \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 8.0 | $\mu \mathrm{A}$ |
| $\mathrm{C}_{1}$ | input capacitance |  | - | 3.5 | - | pF |

Hex buffer/line driver; 3-state

Table 6. Static characteristics 74HC365 ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V ).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | 1.5 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 3.15 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 4.2 | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | - | 0.5 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 1.35 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 1.8 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | 1.9 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 4.4 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 5.9 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-6.0 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 3.84 | - | - | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=-7.8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 5.34 | - | - | V |
| $\mathrm{V}_{\text {OL }}$ | LOW-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | - | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=6.0 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 0.33 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=7.8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 0.33 | V |
| 1 | input leakage current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$; | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| loz | OFF-state output current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | $\pm 5.0$ | $\mu \mathrm{A}$ |
| ICC | supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{GND} ; \mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 80 | $\mu \mathrm{A}$ |
| $\mathrm{Tamb}=-40{ }^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | 1.5 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 3.15 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 4.2 | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | - | 0.5 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 1.35 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 1.8 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | 1.9 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 4.4 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 5.9 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-6.0 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 3.7 | - | - | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=-7.8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 5.2 | - | - | V |

Hex buffer/line driver; 3-state

Table 6. Static characteristics 74HC365 ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V ).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OL}}$ | LOW-level output voltage | $\mathrm{V}_{\text {I }}=\mathrm{V}_{\text {IH }}$ or $\mathrm{V}_{\text {IL }}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | - | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=6.0 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 0.4 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=7.8 \mathrm{~mA} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 0.4 | V |
| 11 | input leakage current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| loz | OFF-state output current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | $\pm 10.0$ | $\mu \mathrm{A}$ |
| ICC | supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 160 | $\mu \mathrm{A}$ |

Table 7. Static characteristics 74HCT365
At recommended operating conditions; voltages are referenced to GND (ground = 0 V ).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V | 2.0 | 1.6 | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V | - | 1.2 | 0.8 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A}$ | 4.4 | 4.5 | - | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=-6.0 \mathrm{~mA}$ | 3.98 | 4.32 | - | V |
| $\mathrm{V}_{\mathrm{OL}}$ | LOW-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=20 \mu \mathrm{~A}$ | - | 0 | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=6.0 \mathrm{~mA}$ | - | 0.16 | 0.26 | V |
| 1 | input leakage current | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | - | - | $\pm 0.1$ | $\mu \mathrm{A}$ |
| loz | OFF-state output current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | - | - | $\pm 0.5$ | $\mu \mathrm{A}$ |
| ICC | supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | - | - | 8.0 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\text {CC }}$ | additional supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}-2.1 \mathrm{~V}$; other inputs at $\mathrm{V}_{C C}$ or GND; $\mathrm{I}_{0}=0 \mathrm{~A}$ |  |  |  |  |
|  |  | pins nA | - | 100 | 360 | $\mu \mathrm{A}$ |
|  |  | pin $\overline{O E 1}$ | - | 100 | 360 | $\mu \mathrm{A}$ |
|  |  | pin $\overline{O E 2}$ | - | 90 | 324 | $\mu \mathrm{A}$ |
| $\mathrm{Cl}_{1}$ | input capacitance |  | - | 3.5 | - | pF |
| $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V | 2.0 | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V | - | - | 0.8 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A}$ | 4.4 | - | - | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=-6.0 \mathrm{~mA}$ | 3.84 | - | - | V |
| $\mathrm{V}_{\mathrm{OL}}$ | LOW-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  |  |  |
|  |  | $\mathrm{l}_{\mathrm{O}}=20 \mu \mathrm{~A}$ | - | - | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=6.0 \mathrm{~mA}$ | - | - | 0.33 | V |
| 1 | input leakage current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| loz | OFF-state output current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ |  |  | $\pm 5.0$ | $\mu \mathrm{A}$ |

Hex buffer/line driver; 3-state

Table 7. Static characteristics 74HCT365 ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V ).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Icc | supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | - | - | 80 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\text {CC }}$ | additional supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{C C}-2.1 \mathrm{~V}$; other inputs at $\mathrm{V}_{C C}$ or GND; $\mathrm{I}_{\mathrm{O}}=0 \mathrm{~A}$ |  |  |  |  |
|  |  | pins nA | - | - | 450 | $\mu \mathrm{A}$ |
|  |  | pin $\overline{O E 1}$ | - | - | 450 | $\mu \mathrm{A}$ |
|  |  | pin $\overline{O E 2}$ | - | - | 405 | $\mu \mathrm{A}$ |
| $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V | 2.0 | - | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V | - | - | 0.8 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  |  |  |
|  |  | $\mathrm{I}_{\mathrm{O}}=-20 \mu \mathrm{~A}$ | 4.4 | - | - | V |
|  |  | $\mathrm{l}_{\mathrm{O}}=-6.0 \mathrm{~mA}$ | 3.7 | - | - | V |
| $\mathrm{V}_{\text {OL }}$ | LOW-level output voltage | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  |  |  |  |
|  |  | $\mathrm{l}_{\mathrm{O}}=20 \mu \mathrm{~A}$ | - | - | 0.1 | V |
|  |  | $\mathrm{I}_{\mathrm{O}}=6.0 \mathrm{~mA}$ | - | - | 0.4 | V |
| 1 | input leakage current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| loz | OFF-state output current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | - | - | $\pm 10.0$ | $\mu \mathrm{A}$ |
| Icc | supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND; $\mathrm{I}_{\mathrm{O}}=0 \mathrm{~A} ; \mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | - | - | 160 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{I}_{\text {CC }}$ | additional supply current | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{C C}-2.1 \mathrm{~V}$; other inputs at $\mathrm{V}_{C C}$ or GND; $\mathrm{I}_{\mathrm{O}}=0 \mathrm{~A}$ |  |  |  |  |
|  |  | pins nA | - | - | 490 | $\mu \mathrm{A}$ |
|  |  | pin $\overline{O E 1}$ | - | - | 490 | $\mu \mathrm{A}$ |
|  |  | pin $\overline{\mathrm{OE} 2}$ | - | - | 441 | $\mu \mathrm{A}$ |

## 10. Dynamic characteristics

Table 8. Dynamic characteristics 74HC365
Voltages are referenced to GND (ground $=0 \mathrm{~V}$ ); $C_{L}=50 \mathrm{pF}$ unless otherwise specified; see test circuit Figure 8.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{pd}}$ | propagation delay | nA to $n Y$; see Figure 6 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=2.0 \mathrm{~V}$ | - | 30 | 95 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | 11 | 19 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} ; \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | - | 9 | - | ns |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=6.0 \mathrm{~V}$ | - | 9 | 16 | ns |
| $\mathrm{t}_{\text {en }}$ | enable time | $\overline{\mathrm{OEn}}$ to nY ; see Figure 7 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | 47 | 150 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | 17 | 30 | ns |
|  |  | $\mathrm{V}_{\mathrm{cc}}=6.0 \mathrm{~V}$ | - | 14 | 26 | ns |
| $\mathrm{t}_{\text {dis }}$ | disable time | $\overline{\mathrm{OEn}}$ to nY ; see Figure 7 [3] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=2.0 \mathrm{~V}$ | - | 61 | 150 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | 22 | 30 | ns |
|  |  | $\mathrm{V}_{\mathrm{cc}}=6.0 \mathrm{~V}$ | - | 18 | 26 | ns |
| $\mathrm{t}_{\mathrm{t}}$ | transition time | see Figure 6 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | 14 | 60 | ns |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=4.5 \mathrm{~V}$ | - | 5 | 12 | ns |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=6.0 \mathrm{~V}$ | - | 4 | 10 | ns |
| $\mathrm{C}_{\text {PD }}$ | power dissipation capacitance | per buffer; $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ to $\mathrm{V}_{\mathrm{CC}}$ | - | 40 | - | pF |
| $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| $\mathrm{t}_{\text {pd }}$ | propagation delay | nA to nY ; see Figure 6 [1] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | - | 120 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 24 | ns |
|  |  | $\mathrm{V}_{\mathrm{cc}}=6.0 \mathrm{~V}$ | - | - | 20 | ns |
| ten | enable time | $\overline{\mathrm{OEn}}$ to nY ; see Figure 7 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | - | 190 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 38 | ns |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=6.0 \mathrm{~V}$ | - | - | 33 | ns |
| $\mathrm{t}_{\text {dis }}$ | disable time | $\overline{\mathrm{OEn}}$ to nY ; see Figure 7 [3] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | - | 190 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 38 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 33 | ns |
| $t_{t}$ | transition time | see Figure 6 [4] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | - | - | 75 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | - | - | 15 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | - | - | 13 | ns |

Table 8. Dynamic characteristics 74HC365 ...continued
Voltages are referenced to GND (ground $=0 \mathrm{~V}$ ); $C_{L}=50 \mathrm{pF}$ unless otherwise specified; see test circuit Figure 8.

| Symbol | Parameter | Conditions |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{pd}}$ | propagation delay | nA to nY ; see Figure 6 | [1] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=2.0 \mathrm{~V}$ |  | - | - | 145 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  | - | - | 29 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ |  | - | - | 25 | ns |
| $\mathrm{t}_{\text {en }}$ | enable time | $\overline{\mathrm{OEn}}$ to nY ; see Figure 7 | [2] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ |  | - | - | 225 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  | - | - | 45 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ |  | - | - | 38 | ns |
| $\mathrm{t}_{\text {dis }}$ | disable time | $\overline{\mathrm{OEn}}$ to nY ; see Figure 7 | [3] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ |  | - | - | 225 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  | - | - | 45 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ |  | - | - | 38 | ns |
| $\mathrm{t}_{\mathrm{t}}$ | transition time | see Figure 6 | [4] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ |  | - | - | 90 | ns |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=4.5 \mathrm{~V}$ |  | - | - | 18 | ns |
|  |  | $\mathrm{V}_{\mathrm{Cc}}=6.0 \mathrm{~V}$ |  | - | - | 15 | ns |

[1] $t_{p d}$ is the same as $t_{\text {PHL }}$ and $t_{\text {PLL }}$.
[2] $t_{\text {en }}$ is the same as $t_{\text {PzH }}$ and $t_{\text {PzL }}$.
[3] $\mathrm{t}_{\text {dis }}$ is the same as $\mathrm{t}_{\text {PHZ }}$ and $\mathrm{t}_{\text {PLZ }}$.
[4] $t_{t}$ is the same as $t_{T H L}$ and $t_{T L H}$.
[5] $\mathrm{C}_{\mathrm{PD}}$ is used to determine the dynamic power dissipation ( $\mathrm{P}_{\mathrm{D}}$ in $\mu \mathrm{W}$ ).
$P_{D}=C_{P D} \times V_{C C}{ }^{2} \times f_{i} \times N+\sum\left(C_{L} \times V_{C C}{ }^{2} \times f_{0}\right)$ where:
$\mathrm{f}_{\mathrm{i}}=$ input frequency in MHz ;
$\mathrm{f}_{\mathrm{o}}=$ output frequency in MHz ;
$\mathrm{C}_{\mathrm{L}}=$ output load capacitance in pF ;
$\mathrm{V}_{\mathrm{CC}}=$ supply voltage in V ;
$N=$ number of inputs switching;
$\Sigma\left(C_{L} \times V_{C C}{ }^{2} \times f_{0}\right)=$ sum of outputs.

Table 9. Dynamic characteristics 74HCT365
Voltages are referenced to GND (ground $=0 \mathrm{~V}$ ); $C_{L}=50 \mathrm{pF}$ unless otherwise specified; see test circuit Figure 8.

| Symbol | Parameter | Conditions |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{pd}}$ | propagation delay | nA to nY ; see Figure 6 | [1] |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ |  | - | 14 | 25 | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} ; \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | - | 11 | - | ns |
| $\mathrm{t}_{\text {en }}$ | enable time | $\overline{\mathrm{OEn}}$ to nY ; $\mathrm{V}_{\mathrm{Cc}}=4.5 \mathrm{~V}$; see Figure 7 | [2] | - | 18 | 35 | ns |
| $\mathrm{t}_{\text {dis }}$ | disable time | $\overline{\mathrm{OEn}}$ to nY ; $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; see $\underline{\text { Figure } 7}$ | [3] | - | 23 | 35 | ns |
| $\mathrm{t}_{\mathrm{t}}$ | transition time | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; see Figure 6 | [4] | - | 5 | 12 | ns |
| $\mathrm{C}_{\text {PD }}$ | power dissipation capacitance | per buffer; $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ to $\left(\mathrm{V}_{\mathrm{CC}}-1.5 \mathrm{~V}\right)$ | [5] | - | 40 | - | pF |

Table 9. Dynamic characteristics 74HCT365 ...continued
Voltages are referenced to GND (ground $=0 \mathrm{~V}$ ); $C_{L}=50 \mathrm{pF}$ unless otherwise specified; see test circuit Figure 8.

| Symbol | Parameter | Conditions |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ to $+85{ }^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{pd}}$ | propagation delay | $n A$ to $\mathrm{nY} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; see Figure 6 | [1] | - | - | 31 | ns |
| ten | enable time | $\overline{\mathrm{OEn}}$ to $\mathrm{nY} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; see Figure 7 | [2] | - | - | 44 | ns |
| $\mathrm{t}_{\text {dis }}$ | disable time | $\overline{\mathrm{OEn}}$ to nY ; $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; see $\underline{\text { Figure } 7}$ | [3] | - | - | 44 | ns |
| $\mathrm{t}_{\mathrm{t}}$ | transition time | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$; see Figure 6 | [4] | - | - | 15 | ns |
| $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{pd}}$ | propagation delay | $n A$ to $\mathrm{nY} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; see Figure 6 | [1] | - | - | 38 | ns |
| $\mathrm{t}_{\text {en }}$ | enable time | $\overline{\mathrm{OEn}}$ to $\mathrm{nY} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; see $\underline{\text { Figure } 7}$ | [2] | - | - | 53 | ns |
| $\mathrm{t}_{\text {dis }}$ | disable time | $\overline{\mathrm{OEn}}$ to $\mathrm{nY} ; \mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; see $\underline{\text { Figure } 7}$ | [3] | - | - | 53 | ns |
| $\mathrm{t}_{\mathrm{t}}$ | transition time | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; see Figure 6 | [4] | - | - | 18 | ns |

[1] $t_{p d}$ is the same as $t_{\text {PHL }}$ and $t_{\text {PLH. }}$.
[2] $t_{\text {en }}$ is the same as $t_{\text {PzH }}$ and $t_{\text {PzL }}$.
[3] $t_{\text {dis }}$ is the same as $t_{\text {PHZ }}$ and $t_{\text {PLZ }}$.
[4] $t_{t}$ is the same as $t_{T H L}$ and $t_{T L H}$.
[5] $\mathrm{C}_{\mathrm{PD}}$ is used to determine the dynamic power dissipation ( $\mathrm{P}_{\mathrm{D}}$ in $\mu \mathrm{W}$ ).
$P_{D}=C_{P D} \times V_{C C}{ }^{2} \times f_{i} \times N+\sum\left(C_{L} \times V_{C C}{ }^{2} \times f_{0}\right)$ where:
$\mathrm{f}_{\mathrm{i}}=$ input frequency in MHz ;
$\mathrm{f}_{\mathrm{o}}=$ output frequency in MHz ;
$C_{L}=$ output load capacitance in pF ;
$\mathrm{V}_{\mathrm{CC}}=$ supply voltage in V ;
$N=$ number of inputs switching;
$\Sigma\left(C_{L} \times V_{C C}{ }^{2} \times f_{0}\right)=$ sum of outputs.

## 11. Waveforms



Measurement points are given in Table 10.
$V_{O L}$ and $V_{O H}$ are typical output voltage levels that occur with the output load.
Fig 6. Propagation delay data input ( nA ) to output ( $\mathrm{n} Y$ ) and output transition time


Measurement points are given in Table 10.
$\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{OH}}$ are typical output voltage levels that occur with the output load.
Fig 7. 3-state enable and disable times

Table 10. Measurement points

| Type | Input | Output |  |  |
| :--- | :--- | :--- | :--- | :--- |
|  | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{X}}$ | $\mathbf{V}_{\mathbf{Y}}$ |
| 74 HC 365 | $0.5 \mathrm{~V}_{\mathrm{CC}}$ | $0.5 \mathrm{~V}_{\mathrm{CC}}$ | $0.1 \times \mathrm{V}_{\mathrm{CC}}$ | $0.9 \times \mathrm{V}_{\mathrm{CC}}$ |
| 74 HCT 365 | 1.3 V | 1.3 V | $0.1 \times \mathrm{V}_{\mathrm{CC}}$ | $0.9 \times \mathrm{V}_{\mathrm{CC}}$ |



Test data is given in Table 11.
Definitions test circuit:
$R_{T}=$ Termination resistance should be equal to output impedance $Z_{o}$ of the pulse generator
$C_{L}=$ Load capacitance including jig and probe capacitance
$\mathrm{R}_{\mathrm{L}}=$ Load resistance
S1 = Test selection switch
Fig 8. Test circuit for measuring switching times

Table 11. Test data

| Type | Input |  | Load |  | S1 position |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{V}_{1}$ | $t_{r}, t_{\text {f }}$ | $\mathrm{C}_{\mathrm{L}}$ | $\mathrm{R}_{\mathrm{L}}$ | $\mathrm{t}_{\text {PHL }}, \mathrm{t}_{\text {PLH }}$ | $\mathrm{t}_{\text {PZH }}, \mathrm{t}_{\text {PHZ }}$ | $\mathrm{t}_{\text {PZL }}, \mathrm{t}_{\text {PLZ }}$ |
| 74HC365 | $\mathrm{V}_{\mathrm{Cc}}$ | 6 ns | $15 \mathrm{pF}, 50 \mathrm{pF}$ | $1 \mathrm{k} \Omega$ | open | GND | $V_{\text {cc }}$ |
| 74HCT365 | 3 V | 6 ns | $15 \mathrm{pF}, 50 \mathrm{pF}$ | $1 \mathrm{k} \Omega$ | open | GND | $\mathrm{V}_{\mathrm{Cc}}$ |

## 12. Package outline



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $\mathrm{D}^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $\mathrm{L}_{\mathrm{p}}$ | Q | v | w | y | $z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.75 | $\begin{aligned} & 0.25 \\ & 0.10 \end{aligned}$ | $\begin{aligned} & 1.45 \\ & 1.25 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.49 \\ & 0.36 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 0.19 \end{aligned}$ | $\begin{gathered} 10.0 \\ 9.8 \end{gathered}$ | $\begin{aligned} & 4.0 \\ & 3.8 \end{aligned}$ | 1.27 | $\begin{aligned} & 6.2 \\ & 5.8 \end{aligned}$ | 1.05 | $\begin{aligned} & 1.0 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 0.7 \\ & 0.6 \end{aligned}$ | 0.25 | 0.25 | 0.1 | $\begin{aligned} & 0.7 \\ & 0.3 \end{aligned}$ | $\begin{aligned} & 8^{\circ} \\ & 0^{\circ} \end{aligned}$ |
| inches | 0.069 | $\begin{array}{\|l\|l} 0.010 \\ 0.004 \end{array}$ | $\begin{aligned} & 0.057 \\ & 0.049 \end{aligned}$ | 0.01 | $\begin{aligned} & 0.019 \\ & 0.014 \end{aligned}$ | $\left.\begin{array}{\|l\|} 0.0100 \\ 0.0075 \end{array} \right\rvert\,$ | $\begin{aligned} & 0.39 \\ & 0.38 \end{aligned}$ | $\begin{aligned} & 0.16 \\ & 0.16 \end{aligned}$ | 0.05 | $\begin{aligned} & 0.244 \\ & 0.228 \end{aligned}$ | 0.041 | $\begin{aligned} & 0.039 \\ & 0.016 \end{aligned}$ | $\begin{aligned} & 0.028 \\ & 0.020 \end{aligned}$ | 0.01 | 0.01 | 0.004 | $\begin{aligned} & 0.028 \\ & 0.012 \end{aligned}$ |  |

Note

1. Plastic or metal protrusions of 0.15 mm ( 0.006 inch) maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |  |
| SOT109-1 | $076 E 07$ | MS-012 |  |  | $99-12-27$ <br> $03-02-19$ |  |

Fig 9. Package outline SOT109-1 (SO16)


DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $L_{p}$ | Q | v | w | y | $Z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2 | $\begin{aligned} & 0.21 \\ & 0.05 \end{aligned}$ | $\begin{aligned} & 1.80 \\ & 1.65 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.38 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & 0.20 \\ & 0.09 \end{aligned}$ | $\begin{aligned} & 6.4 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 5.4 \\ & 5.2 \end{aligned}$ | 0.65 | $\begin{aligned} & 7.9 \\ & 7.6 \end{aligned}$ | 1.25 | $\begin{aligned} & 1.03 \\ & 0.63 \end{aligned}$ | $\begin{aligned} & 0.9 \\ & 0.7 \end{aligned}$ | 0.2 | 0.13 | 0.1 | $\begin{aligned} & 1.00 \\ & 0.55 \end{aligned}$ | $8^{\circ}{ }^{\circ}$ |

## Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT338-1 |  | MO-150 |  | $\square$ ¢ | $\begin{aligned} & 99-12-27 \\ & 03-02-19 \end{aligned}$ |

Fig 10. Package outline SOT338-1 (SSOP16)


DIMENSIONS (mm are the original dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $\mathrm{D}^{(1)}$ | $E^{(2)}$ | e | $\mathrm{HE}_{\mathrm{E}}$ | L | $L_{p}$ | Q | v | w | y | $Z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.1 | $\begin{aligned} & 0.15 \\ & 0.05 \end{aligned}$ | $\begin{aligned} & 0.95 \\ & 0.80 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.30 \\ & 0.19 \end{aligned}$ | $\begin{aligned} & 0.2 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & 5.1 \\ & 4.9 \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 4.3 \end{aligned}$ | 0.65 | $\begin{aligned} & 6.6 \\ & 6.2 \end{aligned}$ | 1 | $\begin{aligned} & 0.75 \\ & 0.50 \end{aligned}$ | $\begin{aligned} & 0.4 \\ & 0.3 \end{aligned}$ | 0.2 | 0.13 | 0.1 | $\begin{aligned} & 0.40 \\ & 0.06 \end{aligned}$ | $\begin{aligned} & 8^{\circ} \\ & 0^{\circ} \end{aligned}$ |

## Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |  |
| SOT403-1 |  | MO-153 |  |  | - |  |

Fig 11. Package outline SOT403-1 (TSSOP16)

## 13. Abbreviations

Table 12. Abbreviations

| Acronym | Description |
| :--- | :--- |
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |

## 14. Revision history

Table 13. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| :--- | :--- | :--- | :--- | :--- |
| 74HC_HCT365 v.4 | 20160127 | Product data sheet | - | 74HC_HCT365 v.3 |
| Modifications: | •Type numbers 74HC365N and 74HCT365N (SOT38-4) removed. |  |  |  |
| 74HC_HCT365 v.3 | 20120905 | Product data sheet | - | 74HC_HCT365_CNV v.2 |
| Modifications: | • The format of this data sheet has been redesigned to comply with the new identity <br> guidelines of NXP Semiconductors. <br> $\bullet$ |  |  |  |
| 74HC_HCT365_CNV v.2 | 19970829 texts have been adapted to the new company name where appropriate. |  |  |  |

## 15. Legal information

### 15.1 Data sheet status

| Document status[1][2] | Product status_[3] | Definition |
| :--- | :--- | :--- |
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

### 15.2 Definitions

Draft - The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet - A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.
Product specification - The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 15.3 Disclaimers

Limited warranty and liability - Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.
In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of NXP Semiconductors.
Right to make changes - NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use - NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.
Applications - Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.
NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.
Limiting values - Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale - NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.
No offer to sell or license - Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control - This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products - Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.
In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations - A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

### 15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## 16. Contact information

For more information, please visit: http://www.nxp.com
For sales office addresses, please send an email to: salesaddresses@nxp.com

## 17. Contents

1 General description ..... 1
2 Features and benefits ..... 1
3 Ordering information. ..... 1
4 Functional diagram ..... 2
5 Pinning information. ..... 3
5.1 Pinning ..... 3
5.2 Pin description ..... 3
6 Functional description ..... 4
7 Limiting values. ..... 4
8 Recommended operating conditions. ..... 5
9 Static characteristics. ..... 5
10 Dynamic characteristics ..... 9
11 Waveforms ..... 11
12 Package outline ..... 14
13 Abbreviations. ..... 17
14 Revision history. ..... 17
15 Legal information ..... 18
15.1 Data sheet status ..... 18
15.2 Definitions. ..... 18
15.3 Disclaimers ..... 18
15.4 Trademarks. ..... 19
16 Contact information ..... 19
17 Contents ..... 20

